

Comlinear CLC406 Wideband, Low Power Monolithic Op Amp

General Description

The CLC406 is a wideband monolithic operational amplifier designed for low-gain applications where power and cost are of primary concern. Operating from \pm 5V supplies, the CLC406 consumes only 50mW of power yet maintains a 160MHz small signal bandwidth and a 1500V/ μ s slew rate. Benefitting from Comlinear's current feedback architecture, the CLC406 offers a gain range of \pm 1 to \pm 10 while providing stable, oscillation free operation without external compensation, even at unity gain.

With its exceptional differential gain and phase, typically 0.02% and 0.02° at 3.58MHz, the CLC406 is designed to meet the performance and cost requirements of high volume composite video applications. The CLC406's large signal bandwidth, high slew rate and high drive capability are features well suited for RGB video applications.

Providing a 12ns settling time to 0.05% (1/2 LSB in 10-bit systems) and -68/-75dBc 2nd/3rd harmonic distortion (2V_{pp} at 10MHz, R_L = 1k Ω), the CLC406 is an excellent choice as a buffer or driver for high speed A/D and D/A converter systems.

Commercial remote sensing applications and battery powered radio transceivers requiring a high performance, low power amplifier will find the CLC406 to be an attractive, cost-effective solution.

Constructed using an advanced, complementary bipolar process and Comlinear's proven current feedback architectures, the CLC406 is available in several versions to meet a variety of requirements.

CLC406AJP	-40°C to +85°C	8-pin plastic DIP
CLC406AJE	-40°C to +85°C	8-pin plastic SOIC
CLC406ALC	-40°C to +85°C	dice
CLC406AMC	-55°C to +125°C	dice qualified to Method 5008,
		MIL-STD-883, Level B
CLC406A8B	-55°C to +125°C	8-pin hermetic CERDIP,
		MIL-STD-883, Level B
CLC406A8D	-55°C to +125°C	8-pin sidebrazed CERDIP,
		MIL-STD-883, Level B
CLC406AJM5	-40°C to +85°C	5-pin SOT

DESC SMD number: 5962-92004

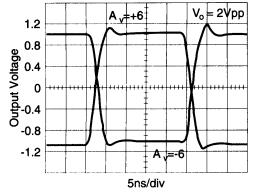
Features

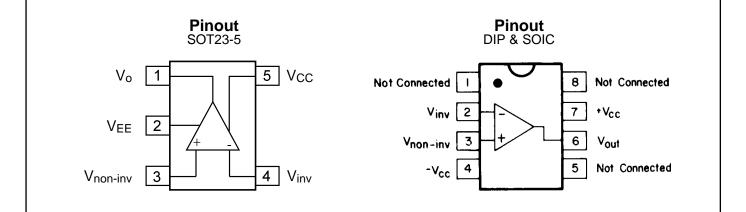
- 160MHz small signal bandwidth
- 50mW power (±5Vsupplies)
- 0.02%/0.02° differential gain/phase
- 12ns settling to 0.05%
- 1500V/µs slew rate
- 2.2ns rise and fall time (2V_{pp})
- 70mA output current

Applications

- Video distribution amp
- HDTV amplifier
- Flash A/D driver
- D/A transimpedance buffer
- Pulse amplifier
- Photodiode amp
- LAN amplifier

Small Signal Pulse Response





CLC406 Electrical Characteristics (A _v = +6, V _{cc} = ±5V, R _L = 100 Ω , R _f = 500 Ω ; unless specified)							
PARAMETERS	CONDITIONS	TYP	MAX & MIN RATINGS		UNITS	SYMBOL	
Ambient Temperature	CLC406AJ/AI	+25℃	-40°C	+25℃	+ 85℃		
Ambient Temperature	CLC406A8/AL/AM	+25°C	_55℃	+25°C	+125°C		
FREQUENCY DOMAIN PE	RFORMANCE						
† – 3db bandwidth ¹	V _{out} <2V _{pp} V _{out} <5V _{pp}	160 130	>110 >95	>110 >95	>90 >80	MHz MHz	SSBW LSBW
	$V_{out}^{out} < 2V_{pp}^{op}$ DC to 25MHz >25MHz DC to 50MHz DC to 50MHz DC to 75MHz v = +2) 150\Omega load, 3.58MHz 4.43MHz	0 0 0.2 0.02 0.02	<0.2 <0.5 <0.6 <0.8 <0.04 <0.04	<0.2 <0.5 <0.6 <0.8 <0.04 <0.04	<0.2 <0.5 <1.0 <1.2 <0.04 <0.04	dB dB dB °	GFPL GFPH GFR LPD DG1 DG2
differential phase (A	$v = +2$) 150 Ω load, 3.58MHz 4.43MHz	0.02	<0.04 <0.05	<0.04 <0.05	<0.08 <0.10	•	DP1 DP2
TIME DOMAIN RESPONSE rise and fall time settling time to 0.05% overshoot slew rate	2V step 4V step 2Vstep 2V step	2.2 3.0 12 8 1500	<3.0 <3.6 <18 <15 >1200	<3.0 <3.6 <18 <15 >1200	<3.9 <5.0 <20 <15 >1000	ns ns ns % V/µs	TRS TRL TS OS SR
DISTORTION AND NOISE 2nd harmonic distortion 3rd harmonic distortion	$\begin{array}{l} \textbf{RESPONSE} \\ & \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	-46 -68 -50 -75	<-42 <-62 <-46 <-70	<-42 <-62 <-46 <-70	<-38 <-60 <-42 <-65	dBc dBc dBc dBc dBc	HD2 HD2L HD3 HD3L
equivalent input noise non-inverting voltage inverting current non-inverting current total noise floor total integrated noise	>1MHz >1MHz >1MHz >1MHz >1MHz 1MHz to 100MHz	2.7 11.0 2.1 -157 31	3.4 13.9 2.6 <-156 <38	3.4 13.9 2.6 <-156 <38	3.8 15.5 3.0 -155 <42	$ \begin{array}{c} nV/\sqrt{Hz} \\ pA/\sqrt{Hz} \\ pA/\sqrt{Hz} \\ dBm_{1Hz} \\ \mu V \end{array} $	VN ICN NCN SNF INV
STATIC, DC PERFORMANC *input offset voltage average temperature c *input bias current average temperature c *input bias current average temperature c †power supply rejection ratio common mode rejection ratio *supply current	oefficient non-inverting oefficient inverting oefficient	2 30 5 30 3 20 50 50 5.0	<10 <60 <24 <125 <23 <100 >46 >45 <7.0	<6 <12 <15 -46 >45 <6.7	<12 <60 <12 <50 <20 <50 >44 >43 <6.7	mV μV/°C μA nA/°C μA dB dB mA	VIO DVIO IBN DIBN IBI DIBI PSRR CMRR ICC
MISCELLANEOUS PERFOI non-inverting input resistance non-inverting input capacitat output impedance output voltage range common mode input range output current	e	1000 1.0 0.2 +3.1, -2.7 ±2.2 70	>300 <2.0 <0.6 +1.6, -2.5 ± 1.4 30	>500 <2.0 <0.3 ±2.7 ±2.0 50		kΩ pF Ω V V mA	RIN CIN RO VO CMIR IO

Min/max ratings are based on product characterization and simulation. Individual parameters are tested as noted. Outgoing quality levels are determined from tested parameters.

Absolute Maximum	Ratings	Miscellaneous Ratings					
V _{cc} I _{out} output is short circuit protected to	±7V	recommende	d gain range: ± 1 to ± 10				
ground, but maximum reliability will be		NOTES:					
maintained if Iout does not exceed	70mA	* AI, AJ	100% tested at + 25°C, sample at + 85°C.				
common mode input voltage	$\pm V_{cc}$	† AJ	Sample tested at + 25°C. 100% tested at + 25°C.				
differential input voltage	10ĬĬ	† AI					
junction temperature	+ 175°C	* A8	100% tested at + 25°C, - 55°C, + 125°C.				
operating temperature range		† A8	100% tested at + 25°C, sample – 55°C, + 125°C.				
AI/AJ:	– 40°C to + 85°C	* AL, AM	100% wafer probe tested at + 25°C to + 25°C				
A8/AM/AL	– 55°C to + 125°C		min/max specifications.				
storage temperature range	– 65°C to + 150°C	note 1:	At – 55°C large signal is 3V _{pp}				
Lead solder duration (+ 300°C)	10 sec	note 2:	Gain flatness tests performed from 0.1MHz				

CLC406 Typical Performance Characteristics (T_A = 25°, A_V = +6, V_{CC} = ±5V, R_L = 100 Ω , R_f = 500 Ω)

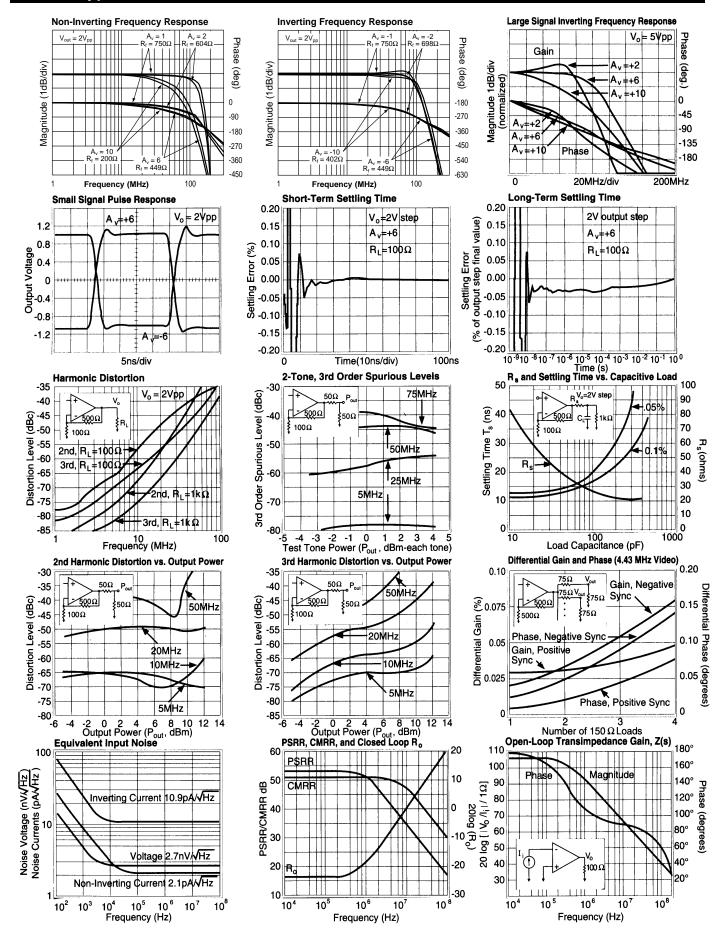
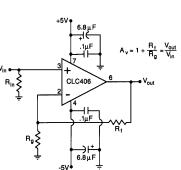


Figure 1: recommended non-inverting gain circuit



Feedback Resistor

The CLC406 achieves its exceptional AC performance while requiring very low quiescent power by using the current feedback topology and an internal slew rate enhancement circuit. The loop gain and frequency response for a current feedback op amp is predominantly set by the feedback resistor value. The CLC406 is optimized for a gain of +6 to use a 500 Ω feedback resistor (for maximally flat response at a gain of +2, use $\mathbf{R}_{f} = \mathbf{1}\mathbf{k}\Omega$). Using lower values can lead to excessive ringing in the pulse response while a higher value will limit the bandwidth. Application Note OA-13 provides a more detailed discussion of choosing a feedback resistor. A plot within the CLC415 data sheet entitled found "Recommended R_f vs. Gain" is also applicable to the CLC406. The values of R_f found on this plot will optimize the performance of the CLC406 over its ± 1 to ± 10 gain range. The CLC406, like all current feedback op amps, can be operated at higher than recommended gains with an expected reduction in bandwidth.

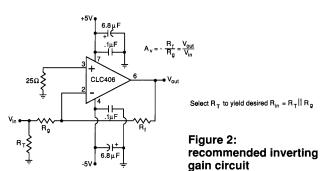
Slew Rate and Harmonic Distortion

The current feedback topology yields an inherently high slew rate amplifier. For this reason the CLC406 shows little difference in bandwidth between $2V_{pp}$ and $5V_{pp}$ outputs. The dominant slew rate limiting mechanism is the unity gain buffer used internally from the non-inverting to the inverting inputs. Using a slew enhancement circuit to sense the onset of slew limiting, the buffer stage momentarily increases the quiescent current to handle high slew requirements. Slew rates will decrease when operating the CLC406 at lower non-inverting gains due to the increasing signal swing through the buffer stage which is necessary to maintain a fixed desired output swing. Conversely, slew rates are generally higher and relatively insensitive to gain setting for inverting gain operation. An additional discussion of slew rates can be found in the CLC404 data sheet.

As the output signal swing is increased, the slew enhancement circuit found in the buffer stage acts to suppress harmonic distortions. This is one reason the CLC406 does not exhibit a simple relationship between output power and distortion. For example, the 2-tone, 3rd order spurious plot shows the spurious level to remain nearly constant over test tone power. For this reason the CLC406 does not exhibit an intercept type performance where the relative spurious levels change at twice the rate of the test tone power.

Differential Gain and Phase

Differential gain and phase performance specifications are common to composite video distribution applications. These specifications refer to the change in small signal gain and phase of the color subcarrier frequency (4.43MHz for PAL composite video) as the amplifier output is swept over a range of DC voltages. For this test only, the CLC406 is specified at a gain of +2 while connected to one or more doubly terminated 75 Ω loads. Application Note OA-



08 provides an additional discussion of differential gain and phase measurements.

Non-inverting Source Impedance

For best operation, the DC source impedance looking out of the non-inverting input should be less than $3k\Omega$ but greater than 20Ω . Parasitic self oscillations may occur in the input transistors if the DC source impedance is out of this range. This impedance also acts as the gain for the non-inverting input bias and noise currents and therefore can become troublesome for high values of DC source impedance. The inverting configuration of Figure 2 shows a 25 Ω resistor to ground on the non-inverting input which insures stability but does not provide bias current cancellation. The input bias currents are unrelated for a current feedback amplifier which eliminates the need for source impedance matching to achieve bias current cancellation.

DC Accuracy and Noise

Figure 3 shows an example of the output offset voltage computation. The calculation is developed using typical bias current and offset voltage specifications at 25°C, a gain (Av) of +6 and a non-inverting source impedance (R_s) of 25 Ω .

Figure 3: Output Offset Voltage Calculation Output Offset Voltage $V_o = (\pm I_{bn}R_{in} \pm V_{io})(1 + R_f/R_g) \pm I_{bi}R_f$ $V_o = (\pm 5\mu A(25\Omega) \pm 2mV)(6) \pm 3\mu A(500\Omega) = \pm 14.25mV$

Improved output offset voltage is possible using the composite circuits shown in Application Note OA-07.

The total output spot noise is computed in a similar fashion to the output offset voltage. Using the input spot noise voltage and the two input spot noise currents, the total output spot noise is developed through the same gain equations for each term but combined as the square root of the sum of squared contributing elements. Application Note OA-12 provides a more detailed discussion of noise calculations for current feedback amplifiers.

Printed Circuit Layout

As with any high speed component, a careful attention to the board layout is necessary for optimum performance. Of particular importance is the careful control of parasitic capacitances on the output pin. As the output impedance plot shows, the closed loop output for the CLC406 eventually becomes inductive as the loop gain rolls off with increasing frequency. Direct capacitive loading on the output pin can quickly lead to peaking in the frequency response, overshoot in the pulse response, ringing or even sustained oscillations. The "Suggested Series R_s vs. C" plot should be used as a starting point when a capacitive load must be driven.

Evaluation boards (part number 730013 for throughhole and 730027 for SOIC) for the CLC406 are available. Further layout suggestions can be found in Application Note OA-15. This page intentionally left blank.

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